PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4275319

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TAEHUI NA	02/10/2017
BYUNG KYU SONG	02/10/2017
SEONG-OOK JUNG	02/10/2017
JUNG PILL KIM	02/09/2017
SEUNG HYUK KANG	02/09/2017

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15274034

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 919-238-2300
Email: dsmith@wt-ip.com
Correspondent Name: W&T/QUALCOMM

Address Line 1: 106 PINEDALE SPRINGS WAY
Address Line 4: CARY, NORTH CAROLINA 27511

ATTORNEY DOCKET NUMBER:	162921/1173-386
NAME OF SUBMITTER:	DAVID M. SMITH
SIGNATURE:	/David M. Smith/
DATE SIGNED:	02/15/2017

Total Attachments: 6

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PATENT REEL: 041259 FRAME: 0098

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ASSIGNMENT

WHEREAS, WE,

- 1. Taehui Na, a citizen of the Republic of Korea, having a mailing address located at 50 Yonsei-ro, Seodaemun-gu, Seoul 120-749, Korea and a resident of Seoul, Korea,
- 2. Byung Kyu Song, a citizen of the Republic of Korea, having a mailing address located at 50 Yonsei-ro, Seodaemun-gu, Seoul 120-749, Korea and a resident of Seoul, Korea,
- 3. Seong-Ook Jung, a citizen of the Republic of Korea, having a mailing address located at 50 Yonsei-ro, Seodaemun-gu, Seoul 120-749, Korea and a resident of Seoul, Korea,
- 4. Jung Pill Kim, a citizen of the United States, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121 and a resident of San Diego, California,
- 5. Seung Hyuk Kang, a citizen of the United States, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121 and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METAL-OXIDE SEMICONDUCTOR (MOS) TRANSISTOR OFFSET-CANCELLING (OC), ZERO-SENSING (ZS) DEAD ZONE, CURRENT-LATCHED SENSE AMPLIFIERS (SAs) (CLSAs) (OCZS-SAs) FOR SENSING DIFFERENTIAL VOLTAGES (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Technologies, Inc. and Yonsei University (hereinafter "ASSIGNEES"), a Delaware corporation and a Korean entity, respectively, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., and 50 Yonseiro, Seodaemun-gu, Seoul 120-749, Korea, respectively, desire to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEES, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 15/274,034 filed September 23, 2016, Qualcomm Reference No. 162921, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEES and its representative to hereafter add herein such application

number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications applications, continuation applications and all issued patents of the United States which may have granted or may be granted thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEES, its successors, its legal representatives, and its assigns, all rights of priority under Assicingly, its substitutions, Treaties, or Agreements, and the entire right, title, and interest International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, applications, tene in part applications, applications, validation applications, utility model patent of addition applications, confirmation applications, validation applications, utility model patent of audition applications thereof, and all issued patents which may have granted or applications, and design applications thereof, and all issued patents which may have granted or applications, and dought for said INVENTIONS in any country or countries foreign to the may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEES, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEES, its successors, its legal representatives, and its assigns all claims for damages and all remedies successors, its regar representation (s) of any of the rights assigned hereby that have or may arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEES, or may accrue hereafter, nave accided pilot not limited to the right to sue for, seek, obtain, collect, recover, and retain damages including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEES, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEES, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT QUALCOMM Ref No. 162921 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	Seral	.on_Feb/10/2019 DATE	A
~	LOCATION	DATE	Tachui Na
Done at_	LOCATION	_on <u>Feb/10/2019</u> DATE	Byung Kyu Song
Done at	Seoul LOCATION	_on <i>Teb //o/>-o1</i> 9 DATE	Joy Long Ble Seong-Ook Jung
Done at	LOCATION	onDATE	Jung Pill Kim
Done at	LOCATION	on	Senng Hyuk Kang

ASSIGNMENT

WHEREAS, WE,

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- 5. Seung Hyuk Kang, a citizen of the United States, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121 and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METAL-OXIDE SEMICONDUCTOR (MOS) TRANSISTOR OFFSET-CANCELLING (OC), ZERO-SENSING (ZS) DEAD ZONE, CURRENT-LATCHED SENSE AMPLIFIERS (SAs) (CLSAs) (OCZS-SAs) FOR SENSING DIFFERENTIAL VOLTAGES (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Technologies, Inc. and Yonsei University (hereinafter "ASSIGNEES"), a Delaware corporation and a Korean entity, respectively, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., and 50 Yonseiro, Seodaemun-gu, Seoul 120-749, Korea, respectively, desire to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEES, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 15/274,034 filed September 23, 2016, Qualcomm Reference No. 162921, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEES and its representative to hereafter add herein such application

number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications applications, continuation applications and all issued patents of the United States which may have granted or may be granted thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEES, its successors, its legal representatives, and its assigns, all rights of priority under Assicingly, its substitutions, Treaties, or Agreements, and the entire right, title, and interest International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, applications, tene in part applications, applications, validation applications, utility model patent of addition applications, confirmation applications, validation applications, utility model patent of audition applications thereof, and all issued patents which may have granted or applications, and design applications thereof, and all issued patents which may have granted or applications, and dought for said INVENTIONS in any country or countries foreign to the may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEES, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEES, its successors, its legal representatives, and its assigns all claims for damages and all remedies successors, its regar representation (s) of any of the rights assigned hereby that have or may arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEES, or may accrue hereafter, nave accided pilot not limited to the right to sue for, seek, obtain, collect, recover, and retain damages including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEES, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEES, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT QUALCOMM Ref. No. 162921 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on	
LOCATION	, on DATE	Taehui Na
Done atLOCATION	, on	Byung Kyu Song
Done atLOCATION	on N DATE	Seong-Ook Jung
Done at San Diggi LOCATIO	o, on <u>02/09/201</u> 7 N DATE	Jung Pill Kim
Done at San Die	90, on 02/09/2017	Seung Hyuk Kang

PATENT REEL: 041259 FRAME: 0105

RECORDED: 02/15/2017